A YAGEO company

Overview

The R53 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V–0. The R53 series is ideal for harsh environmental conditions and meets the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.

Applications

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock. Typical applications include connection in series with the mains, capacitive power supplies and energy meters, with special emphasis in automotive applications for severe ambient conditions such as On Board Chargers.

Benefits

- Approvals: ENEC, UL, cUL, CQC
- X2 CLASS (IEC 60384-14)
- THB Grade IIIB: 85°C, 85% RH, 1,000 hours at 310 VAC acc. to IEC 60384-14
- THB Grade IIIB: 85°C, 85% RH, 1,000 hours at 560 VDC acc. to IEC 60384-14
- Rated voltage: 310 VAC 50/60 Hz
- Recommended DC Voltage ≤ 630 VDC
- Capacitance range: 0.1 22 μF
- Lead spacing: 15.0 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/110/56, IEC 60068-1
- Tape & Reel in accordance with IEC 60286-2
- · RoHS compliant and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 1,900 VDC
- · Self healing properties
- Automotive (AEC-Q200) grade

Part Number System

1011728 ¹⁰ 1011728 ¹⁰ 101070 101000 100070 1000

R53	3	I.	3470	00	P0	Μ
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X2, Metallized Polypropylene	3 = 310	l = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	P0 P1 P2 P3	K = ±10% M = ±20%



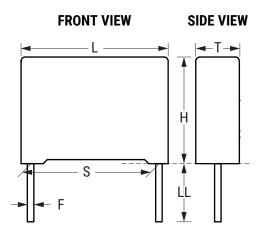
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Pizza Pack – Short Leads	4 +2/-0	BB
	Ammo Pack	$H_0 = 18.5 \pm 0.5$	DQ
	Other Lead and Packaging Options		
15	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	СК
10	Bulk (Bag) – Short Leads	2.7 +0.5/-0	JA
22.5	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
27.5	Bulk (Tray) – Short Leads	4 +2/-0	00
	Pizza Pack – Short Leads Tape & Reel (Large Reel)	4 +2/-0	BB CK ¹
	Other Lead and Packaging Options	H ₀ = 18.5 ±0.5	UK.
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Pizza Pack – Short Leads	4 +2/-0	00
	Other Lead and Packaging Options		
	Pizza Pack – Short Leads	2.7 +0.5/-0	JA
37.5	Pizza Pack – Short Leads	3.5 +0.5/-0	JB
	Pizza Pack – Short Leads	4.0 +0.5/-0	JE
	Pizza Pack – Short Leads	3.2 +0.3/-0.2	JH
	Pizza Pack – Long Leads	18 ±1	JM
	Pizza Pack – Long Leads	30 +5/-0	40
	Pizza Pack – Long Leads	25 +2/-1	50

¹ Not for all sizes, see "Packaging Quantities" table.



Dimensions – Millimeters



	S T H L		F						
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
15.0	±0.4	5.0	+0.3/-0.5	11.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.3/-0.5	12.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.3/-0.5	13.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.3/-0.5	18.5	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	8.5	+0.3/-0.5	14.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	9.0	+0.3/-0.5	12.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	10.0	+0.3/-0.5	16.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.3/-0.5	19.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.3/-0.5	15.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.3/-0.5	16.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	8.5	+0.3/-0.5	17.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.3/-0.5	18.5	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	11.0	+0.3/-0.5	20.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.3/-0.5	22.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
27.5	±0.4	11.0	+0.3/-0.7	20.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.3/-0.7	22.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	14.0	+0.3/-0.7	28.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	16.0	+0.3/-0.7	30.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	22.0	+0.3/-0.7	37.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
37.5	±0.4	20.0	+0.3/-0.7	40.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	24.0	+0.3/-0.7	44.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	30.0	+0.3/-0.7	45.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
		Note: Se	e Ordering O	ptions Tabl	e for lead ler	ngth (LL/H _o)	options.		



Performance Characteristics

Dielectric	Polypropylene film					
Plates	Metal layer deposited by	evaporation under vacuum				
Winding	Non-inductive type					
Leads	Tinned wire					
Protection	Plastic case, thermosettin	g resin filled. Box material is so	olvent resistant and flame retain	ardant according to UL94.		
Related Documents	IEC 60384-14, EN 60384-14					
Rated Voltage V _R	310 VAC (50/60 Hz)					
Recommended DC Voltage	≤ 630 VDC					
Capacitance Range	0.1 −22 µF					
Capacitance Values	E6 series (IEC 60063) me	easured at 1 kHz and +20 ±1°	°C			
Capacitance Tolerance	±10%, ±20%					
Temperature Range	-40°C to +110°C					
Climatic Category	40/110/56 IEC 60068-1					
	Storage time: ≤ 24 months from the date marked on the label package					
	Average relative humidity per year ≤ 70%					
Storage Conditions	RH \leq 85% for 30 days randomly distributed throughout the year					
	Dew is absent					
	Temperature: -40 to 80°	C (see "Maximum Humidity i	n Storage Conditions" grap	h below)		
Approvals	ENEC, UL, cUL, CQC					
	C ≤ ().1 μF	C > ().1µF		
Dissipation Factor (tanδ) at 1 kHz	0.	3%	0.:	2%		
Test Voltage Between Terminals	The 100% screening factory test is carried out at 1,900 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. This test cannot be repeated, as there is a risk of damaging the capacitor. KEMET is not liable in such cases for any failures.					
	Measured at +25°C ±5°C, according to IEC 60384–2					
hand store Destate		Minimum Values B	etween Terminals			
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF		
	100 VDC	1 minute	≥ 1 • 10 ⁵ MΩ (≥ 5 • 10 ⁵ MΩ)*	≥ 30,000 MΩ • μF (≥ 150,000 MΩ • μF)*		

* Typical value

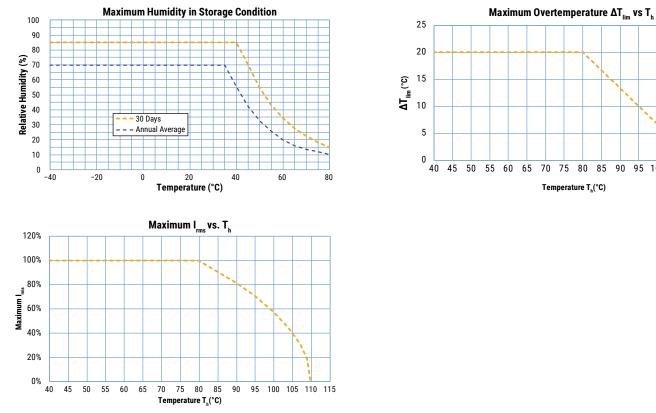


90 95 100 105 110 115

75 80

85

Performance Characteristics cont.



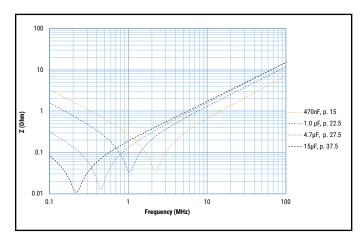
 $T_{\rm k}$ is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.

Qualification

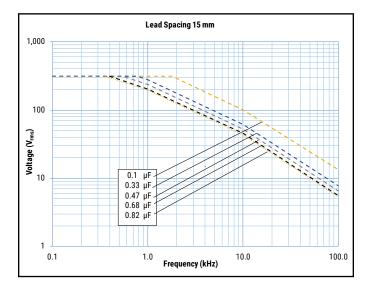
Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit the website at www.aecouncil.com.

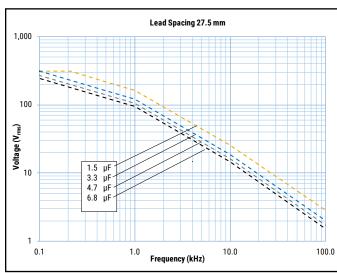


Impedance Graph

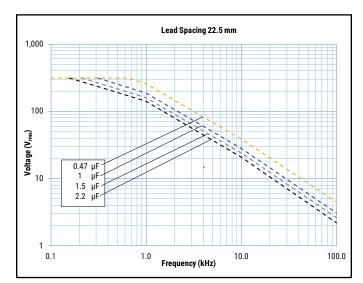


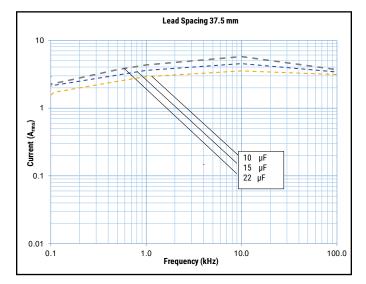
Maximum Voltage (V_{rms}) Versus Frequency (Sinusoidal Waveform/Th \leq 80°C)





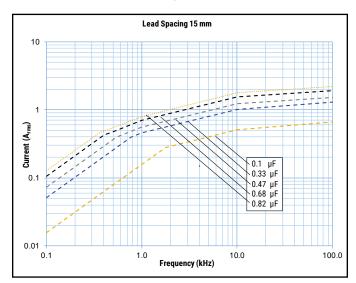
© KEMET Electronics Corporation • KEMET Tower • One East Broward Boulevard Fort Lauderdale, FL 33301 USA • 954-766-2800 • www.kemet.com

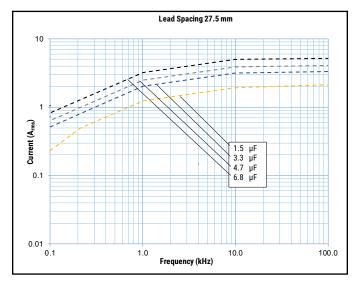


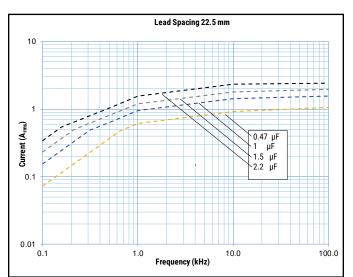


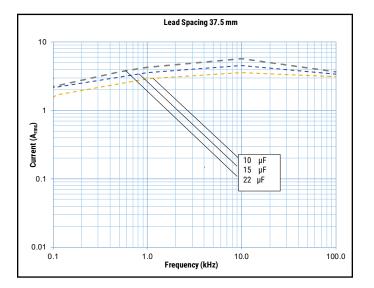


Maximum Current (I_{rms}) Versus Frequency (Sinusoidal Waveform/Th \leq 80°C)











Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Endurance	IEC 60384-14	1.25 x 630 VDC, 1,000 hours at upper rated temperature
Vibration	MIL-STD-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations. Use 8" X 5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
Temperature Cycling	JESD22-Method JA-104	1,000 cycles (-40°C to 110°C) Note: Measurement at 24 ±4 hours after test conclusion. 30 minute maximum dwell time at each temperature extreme. 1 minute maximum transition time.
Active Flammability	IEC 60384-14	V_{R} + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Discod Humidity	According to Grade IIIB (Certification pending)	85°C/85% RH and 310 VAC, 1,000 hours Capacitance change (Δ C/C): \leq 10% Dissipation factor change (Δ tan δ): \leq 24 * 10 ⁻³ (at 10 kHz) for C \leq 1 µF Dissipation factor change (Δ tan δ): \leq 15 * 10 ⁻³ (at 1 kHz) for C > 1 µF Insulation resistance Rins or time constant τ = CR Rins: \geq 50% of initial limit
Biased Humidity	According to Grade IIIB (Certification pending)	85°C/85% RH and 560 VAC, 1,000 hours Capacitance change (Δ C/C): $\leq 10\%$ Dissipation factor change (Δ tan δ): $\leq 24 * 10^{-3}$ (at 10 kHz) for C $\leq 1 \mu$ F Dissipation factor change (Δ tan δ): $\leq 15 * 10^{-3}$ (at 1 kHz) for C > 1 μ F Insulation resistance Rins or time constant τ = CR Rins: $\geq 50\%$ of initial limit

Approvals

Certification Body	Mark	Specification	File Number
IMQ S-p.A.		EN/IEC 60384-14	CA08.00232
UL	c S US	UL 60384–14 and CAN/CSA E60384–14 (310 VAC)	E97797
CQC	Cec	IEC 60384-14	CQC20001267604 CQC20001267618 CQC20001267599 CQC20001267617 CQC20001267606 CQC20001267616



Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.



Table 1 – Ratings & Part Number Reference

Capacitance	Dime	ensions ir	n mm	Lead Spacing dV/dt		KEMET	Legacy Part
Value (µF)	Т	Н	L	(S)	(V/µs)	Part Number	Number
0.10	5.0	11.0	18.0	15.0	400	533I3100(1)P0(2)	R533I3100(1)P0(2)
0.15	5.0	11.0	18.0	15.0	400	533I3150(1)P0(2)	R533I3150(1)P0(2)
0.22	6.0	12.0	18.0	15.0	400	533I3220(1)P0(2)	R533I3220(1)P0(2)
0.33	7.5	13.5	18.0	15.0	400	533I3330(1)P0(2)	R533I3330(1)P0(2)
0.33	9.0	12.5	18.0	15.0	400	523I3330(1)P1(2)	R523I3330(1)P1(2)
0.47	8.5	14.5	18.0	15.0	400	533I3470(1)P0(2)	R533I3470(1)P0(2)
0.47	9.0	12.5	18.0	15.0	400	533I3470(1)P1M	R533I3470(1)P1M
0.47	7.5	18.5	18.0	15.0	400	533I3470(1)P3(2)	R533I3470(1)P3(2)
0.56	10.0	16.0	18.0	15.0	400	533I3560(1)P0(2)	R533I3560(1)P0(2)
0.68	10.0	16.0	18.0	15.0	400	533I3680(1)P1M	R533I3680(1)P1M
0.68	11.0	19.0	18.0	15.0	400	533I3680(1)P0(2)	R533I3680(1)P0(2)
0.82	11.0	19.0	18.0	15.0	400	533I3820(1)P0M	R533I3820(1)P0M
0.47	6.0	15.0	26.5	22.5	200	533N3470(1)P1(2)	R533N3470(1)P1(2)
0.56	6.0	15.0	26.5	22.5	200	533N3560(1)P1M	R533N3560(1)P1M
0.56	7.0	16.0	26.5	22.5	200	533N3560(1)P0(2)	R533N3560(1)P0(2)
0.68	7.0	16.0	26.5	22.5	200	533N3680(1)P0(2)	R533N3680(1)P0(2)
0.82	8.5	17.0	26.5	22.5	200	533N3820(1)P1(2)	R533N3820(1)P1(2)
1.0	8.5	17.0	26.5	22.5	200	533N4100(1)P1M	R533N4100(1)P1M
1.0	10.0	18.5	26.5	22.5	200	533N4100(1)P0(2)	R533N4100(1)P0(2)
1.2	10.0	18.5	26.5	22.5	200	533N4120(1)P0(2)	R533N4120(1)P0(2)
1.5	10.0	18.5	26.5	22.5	200	533N4150(1)P1M	R533N4150(1)P1M
1.5	11.0	20.0	26.5	22.5	200	533N4150(1)P0(2)	R533N4150(1)P0(2)
1.8	11.0	20.0	26.5	22.5	200	533N4180(1)P1M	R533N4180(1)P1M
1.8	13.0	22.0	26.5	22.5	200	533N4180(1)P0(2)	R533N4180(1)P0(2)
2.2	13.0	22.0	26.5	22.5	200	533N4220(1)P0M	R533N4220(1)P0M
1.5	11.0	20.0	32.0	27.5	150	533R4150(1)P0(2)	R533R4150(1)P0(2)
1.8	11.0	20.0	32.0	27.5	150	533R4180(1)P0(2)	R533R4180(1)P0(2)
2.2	13.0	22.0	32.0	27.5	150	533R4220(1)P0(2)	R533R4220(1)P0(2)
2.7	14.0	28.0	32.0	27.5	150	533R4270(1)P0(2)	R533R4270(1)P0(2)
3.3	14.0	28.0	32.0	27.5	150	533R4330(1)P0(2)	R533R4330(1)P0(2)
3.9	14.0	28.0	32.0	27.5	150	533R4390(1)P0(2)	R533R4390(1)P0(2)
4.7	14.0	28.0	32.0	27.5	150	533R4470(1)P1M	R533R4470(1)P1M
4.7	16.0	30.0	32.0	27.5	150	533R4470(1)P2(2)	R533R4470(1)P2(2)
5.6	16.0	30.0	32.0	27.5	150	533R4560(1)P0M	R533R4560(1)P0M
6.8	22.0	37.0	32.0	27.5	150	533R4680(1)P0(2)	R533R4680(1)P0(2)
8.2	22.0	37.0	32.0	27.5	150	533R4820(1)P0(2)	R533R4820(1)P0(2)
10.0	20.0	40.0	42.0	37.5	100	533W5100(1)P0(2)	R533W5100(1)P0(2)
12.0	24.0	40.0	42.0	37.5	100	533W5120(1)P0(2)	R533W5120(1)P0(2)
15.0	24.0	44.0	42.0	37.5	100	533W5120(1)P0(2)	R533W5120(1)P0(2)
18.0	30.0	44.0	42.0	37.5	100	533W5180(1)P0(2)	R533W5180(1)P0(2)
20.0	30.0	45.0	42.0	37.5	100	533W5200(1)P0(2)	R533W5100(1)P0(2)
22.0	30.0	45.0	42.0	37.5	100	533W5220(1)P0(2)	R533W5220(1)P0(2)
apacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.
(2) M = ±20%, K = ±10%



Soldering Process

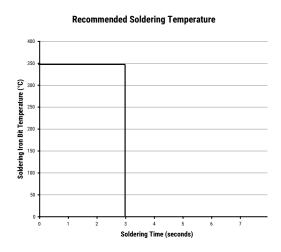
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

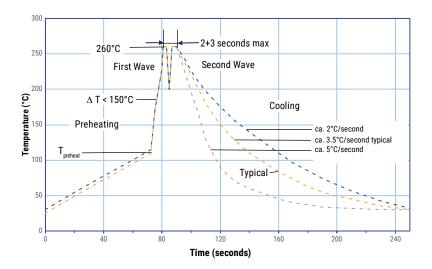
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

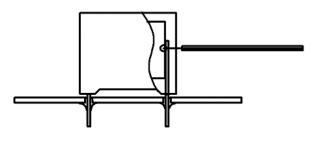
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric	Maxi Prel Tempe	heat	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≥ 10 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	270°C	270°C	
Polypropylene	110°C	130°C	260°C	270°C	
Paper	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



Mounting

Resistance to Vibration and Mechanical Shock

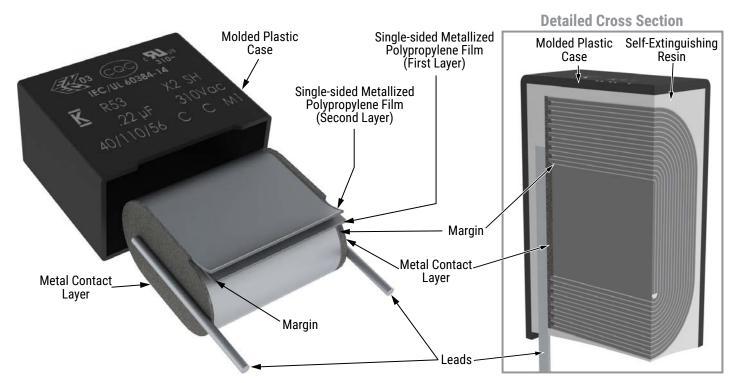
AEC-Q200 Mechanical Stress Tests:					
Mechanical Shock	MIL-SDT-202 Method 213	Test condition C Peak value 100 g, duration 6 ms, half-sine-wave (see MIL-HDBK for details)			
Vibration	MIL-SDT-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations Use 8"X5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.			

The capacitors are designed for PCB mounting.

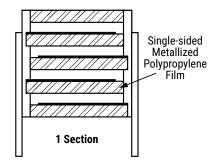
The stand-off pipes must be in good contact with the printed circuit board.

The capacitor body has to be properly fixed (e.g. clamped or glued).

Construction

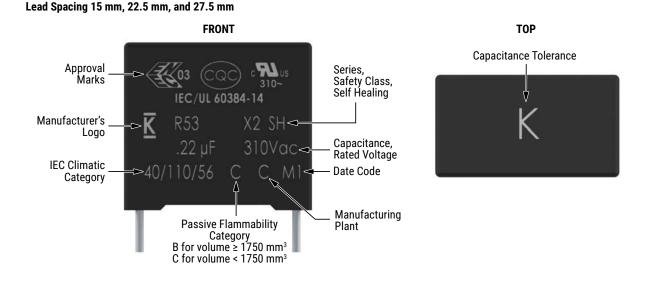


Winding Scheme

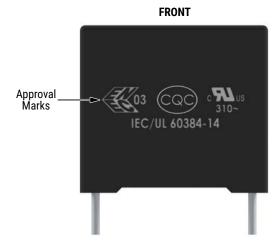




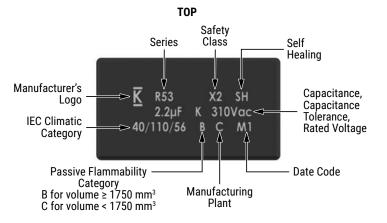
Marking



Lead Spacing 27.5 mm (alternatives*) and 37.5 mm



*Differences are caused by technology (clichee, laser, or ink) and production line.



Manufacturing Date Code (IEC-60062)								
Year	Code	Year	Code	Month	Code	Month	Code	
2010	Α	2020	М	January	1	July	7	
2011	В	2021	Ν	February	2	August	8	
2012	С	2022	Р	March	3	September	9	
2013	D	2023	R	April	4	October	0	
2014	E	2024	S	May	5	November	Ν	
2015	F	2025	Т	June	6	December	D	
2016	Н	2026	U					
2017	J	2027	V					
2018	K	2028	W					
2019	L	2029	Х					



Packaging Quantities

Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped	Pizza
15	5	11	18	2,000	1,000	600	1,250	800	1,122
	6	12	18	1,750	900	500	1,000	680	935
	7.5	13.5	18	1,000	700	350	800	500	748
	7.5	18.5	18	900	500	-	800	500	748
	8.5	14.5	18	1,000	500	300	700	440	663
	9	12.5	18	1,000	520	270	650	410	612
	10	16	18	750	500	300	600	380	561
	11	19	18	450	350	-	500	340	510
		. –							
	6	15	26.5	805	500	-	700	464	660
	7	16	26.5	700	500	-	550	380	564
22.5	8.5	17	26.5	468	300	-	450	280	468
22.5	10	18.5	26.5	396	300	-	350	235	396
	11	20	26.5	360	250	-	350	217	360
	13	22	26.5	300	200	-	300	-	300
	11	20	32	560	336	-	350	-	300
	13	22	32	480	288	-	300	-	250
27.5	14	28	32	352	176	-	-	-	230
	16	30	32	288	144	-	-	-	200
	22	37	32	168	112	-	-	-	150
	20	40	42	-	-	-	-	-	58
37.5	24	44	42	-	-	-	-	-	44
	30	45	42	-	-	-	-	-	36

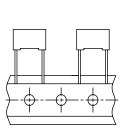
Figure 2

Lead Spacing 15 mm



Lead Taping & Packaging (IEC 60286-2)





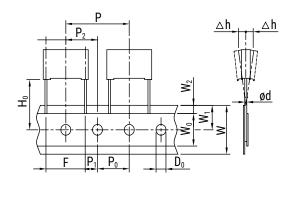
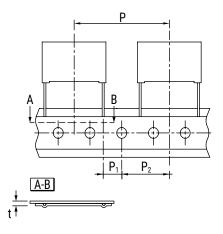


Figure 3 Lead Spacing 22.5 – 27.5 mm



Taping Specification

	Symbol	Dimensions (mm)					
Description							
Description		10	15	22.5	27.5	Tol.	
		Fig. 1	Fig. 2	Fig. 3	Fig. 3		
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05	
Taping lead space	Р	25.4	25.4	38.1	38.1	±1	
Feed hole lead space *	P ₀	12.7	12.7	12.7	12.7	±0.2 **	
Centering of the lead wire	P ₁	7.7	5.2	7.8	5.3	±0.7	
Centering of the body	P ₂	12.7	12.7	19.05	19.05	±1.3	
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1	
Component alignment	Δh	0	0	0	0	±2	
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	±0.5	
Carrier tape width	W	18	18	18	18	+1/-0.5	
Hold down tape width	W ₀	9	10	10	10	Minimum	
Hole position	W ₁	9	9	9	9	±0.5	
Hold down tape position	W ₂	3	3	3	3	Maximum	
Feed hole diameter	D ₀	4	4	4	4	±0.2	
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2	

* 15 mm also available

** Maximum of 1 mm on 20 lead spaces

*** Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

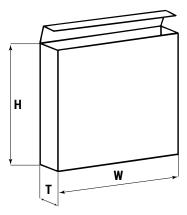
**** H_0 = 16.5 mm is available upon request



Lead Taping & Packaging (IEC 60286-2) cont.

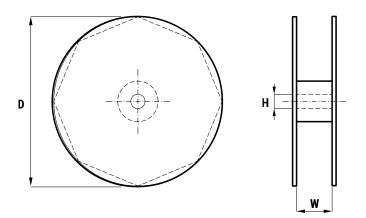
Ammo Specifications

Dimensions (mm)						
Н	W	т				
360	340	59				



Reel Specifications

Reel Size	Dimensions (mm)				
Reel Size	D	Н	W		
Standard	355	30	EE Maximum		
Large	500		55 Maximum		





KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

KEMET is a registered trademark of KEMET Electronics Corporation.